

Product Specification

Class 1

# **PRODUCT SPECIFICATION** ACTION PIN CONTACTS

STOCK THICKNESS	0.8MM
PLATED THROUGH HOLE CLASS	1.35MM
ACTION PIN ZONES	2

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### 1. AREAS OF APPLICATION

### 1.1 Contents

The present specification describes the design, characteristics, types, tests and quality requirements of ACTION PIN contacts. The press-fit region of the ACTION PIN contacts is designed for a PCB with a plated through hole diameter of 1.35 mm (nominal) and a circuit board thickness of 1.6 mm. A mating contact (i.e. JPT or MCP 2.8) for blade terminals with 2.8 x 0.8 mm tabs shall be used to contact the mating side region of the ACTION PIN contact.

### 1.2 General conditions

All tests which are implemented with the contact system, the must correspond with the test guidelines listed in this specification.

- > Circuit board thickness:  $1.6 \pm 0.2$  mm
- Material quality: min. FR4
- Circuit board hold design based on DIN EN 60 352-5; 2.4
- Storage temperature: -40℃ to 125℃
- Maximum authorized voltage according to IEC 664 / IEC 664A (DIN VDE 0110)

### 2. ADDITIONAL DOCUMENTS

### 2.1 General documents

AK test guidelines for vehicle plugs (1996-04 edition)

Other standards:

- A DIN 17 666/12.83 Low alloy copper-wrought alloy
- B DIN 17 670/06.69 Technical delivery conditions
- C DIN 40 802/02.76 part 2 Metal clad base materials for pressed circuits
- D DIN EN 60 352-5 Non-soldered electrical connection
- E DIN 41 640 Measuring and testing procedures for electrical – mechanical elements
- F DIN 40 046 Environmental testing for electronics
- G DIN 41 639/03.76 part 1 (IEC 50 part 581) Electrical – mechanical elements
- H DIN 50 15/10.73 Climates and their technical application, constant test climates
- I DIN 50 017/10.82 Condensate test climates



### 2.2 Product overview

All geometric establishments and requirements: See customer drawings

### 3. **REQUIREMENTS**

### 3.1 Contact design

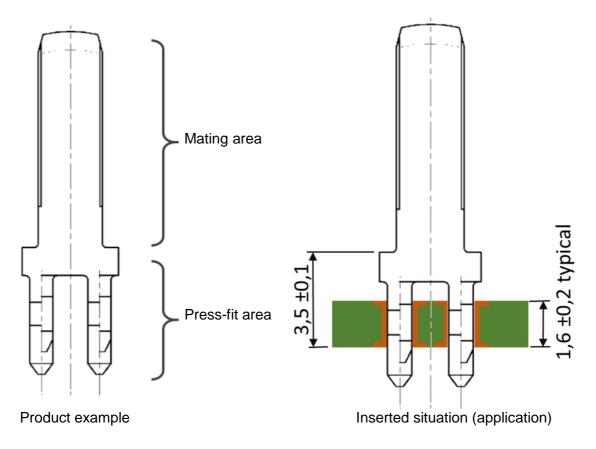
Design, construction and dimensions of ACTION PIN contacts correspond to the drawing documents and are checked in accordance to TE Connectivity quality guidelines. The pin contact is divided into press-fit and mating area.

### Press-fit area:

The ACTION PIN press-fit zone shall be pressed into a metallized circuit board hole with 1.35 mm nominal final hole diameter. The press-fit area of the ACTION PIN contact consists of two spring bars, generating an overall cross section larger than the corresponding circuit board holes. When inserting into the circuit board, the press-fit area is elastically deformed and, thus, provides a secure electrical contact and a highly fixed position of the ACTION PIN zone in the circuit board.

### Mating area:

The mating area is designed as a contact tab with a cross-section of 2.8 x 0.8 mm. It has a geometrically defined tip to minimize the mating force. The mating connector is a socket contact (i.e. JPT or MCP 2.8) for the tab contact. Contact mating area and socket contact must feature an identical surface plating in the contact area.





#### 3.2 **Materials**

- А Basic material copper-coated alloy based on TE connectivity specification: See drawing
- В Coating - press-on area: See drawing
- С Coating - press-in area: See drawing

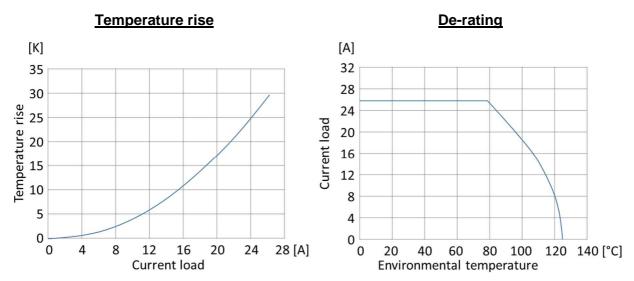
#### 3.3 **Requirements and tests**

Test description	Requirement	Test	
Visual and measurement test	Fulfill requirements according Based on IEC 512-2,		
	to drawing documents	and 1b	
Electrical tests			
Current capacity	The different values result, dependent on the application and		
Max. current heating	execution; therefore, consider illustration 3.3A. If no		
Current heating based on	comparable examples are contained, the user must have the		
environmental simulation	individual case tested or checked.		

### 3.3 A

### **Example:**

- pin: 2.8x0.8 terminal with ACTION PIN, PN 1-929277-2, material: CuSn4 tin-plated; •
- socket: contact PN 965999-2, material: CuSn tin-plated, 2.5 mm2 stranded conductor circuit board: PCB Cu thickness: 0.070 mm •
- •



Mechanical tests			
Retention force of the	>= 80 N	Based on IEC 5 12-8, test 15a	
ACTION PIN zone in the	(contact surface Sn)	Test velocity:	
circuit board in new condition	(circuit board hole Sn)	25 mm/min	
Retention forces of the	>=80 N	Based on IEC 5 12-8, test 15a	
ACTION PIN in the circuit	(contact surface Sn)	Test velocity:	
board based after	(circuit board hole Sn)	25 mm/min	
environmental simulation			
	120-400 N	Test velocity:	
Insertion forces	(contact surface Sn)	25 mm/min	
	(circuit board hole Sn)		



Environmental simulation based on PG 19 / AK test guidelines for vehicle plug connectors (deviation: limit temperature: 125°C, h umidty cycl.: 21 days)		
Temperature shock		Based on IEC 68 T.2-14,
	The contact resistance must	duration: 144 cycles,
	not exceed the following	temperature: -40°C / 125°C
Temperature change	threshold:	Based on IEC 68 T.2-14,
	Resistance change > 1	duration: 20 cycles /
	mOhm	temperature: 40°C / 125°C
	In any test	each 3 h
Dry heat storage		Based on EN 6068-2-2,
	If the contacts are loaded for at least 15 minutes thereafter	duration 120 h, temperature 125°C
Industry climate	with rated current, the current	Based on DIN 41640 T.72
	heating may amount to 20°C	(0.02 ppm SO2, 0.02 ppm
	more than with a new contact.	H2S,, 0.2 ppm NO2 , 0.01
		ppm Cl2,
	In the contact zone area, no	duration: 21 d / 7% r.h. / 25°
	corrosion may occur.	C flow velocity: 1 m3 /h
Humidity cycling		Based on IEC 68 T.2-30,
	The mechanical function of	duration 21 cycles each 24 h /
	the plug must be ensured.	Tu= 25°C, To = 55°C / 95%
	4	r.h.
Vibration test		f: 15 – 1000 Hz, a = 10g,
3 room axis	4	duration 6 h each room axis
Mechanical shock		Based on EN 60068-2-27,
3 room axis		a=30g, t=6ms, half shaft sinus
		shaped 50 shocks each room
		axis

## 3.4 Test sequence

	Test group <sup>1</sup>			
Test	А	В	C	D
	Test sequence <sup>2</sup>			
Visual and measurement	1	1	1	
test				
Current capacity			2	
Holding force of the contacts	2	3		
in the circuit board				
(opposite direction of				
equipment)				
Environmental simulation		2		
with vibration testing (PG 19)				

see section 4.1 A
the number show

2) the number show the sequence in which the tests occur.



### 4. QUALITY ASSURANCE MEASURES

### 4.1 Qualification tests A Selection of test item

The test samples must correspond to the drawing documents. They should be taken from regular production on a random basis.

Test group A: 20 individual contacts Test group B: 20 individual contacts Test group C: 20 individual contacts

### B Test groups

The tests must be implemented according to the test groups listed under section 3.4.

### 4.2 Requalification tests

If significant characteristics of shape, equipment or function of the product or its manufacturing procedure were changed, the responsible development department shall coordinate a requalification test. This consists of a part or the entire original testing group, depending on definitions made by the development and quality assurance department.

### 4.3 Acceptance

Acceptance is based on the proof that the product satisfies the requirements in section 3.3. Deviations that result from gauges, measuring apparatus or operating deficiency may not result in revocation of qualification. If a deviation occurs, corrective actions must be taken, and the qualification must be newly proven. Before requalification, the success of the corrective action must be confirmed by appropriate tests.

### 4.4 Testing and conformity

The conformity testing occurs based on the associated quality inspection plan which established the acceptable quality limit based on random sample scopes. Dimensional and functional requirements must correspond to the product drawings and this specification.